

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
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CORRESPONDENCE DATA													
Fax Number:	4259689795												
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>													
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OP \$40.00 13736834

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ATTORNEY DOCKET NUMBER:	100IM-036900US
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NAME OF SUBMITTER:	Steve Y. Cho
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Total Attachments: 1 source=2013_01_11_ASSGMT-100IM-036900US#page1.tif

ASSIGNMENT OF PATENT APPLICATION

WHEREAS, the below named individual(s), hereinafter referred to as "Assignors," are the inventor(s) of the invention described and set forth in the below-identified application for United States Letters Patent:

Title of Invention: POLISHING SLURRY AND CHEMICAL
MECHANICAL PLANARIZATION METHOD USING
THE SAME

Filing Date: January 8, 2013

Application No.: 13/736,834

WHEREAS, SK hynix, Inc. of 2991, Gyeongchung-daero, Bobsal-eub, Icheon-si, Gyeonggi-do 467-734, Republic of Korea, and KOREA UNIVERSITY RESEARCH AND BUSINESS FOUNDATION of 145, Anam-ro, Seongbuk-gu, Seoul 136-701, Republic of Korea, hereinafter referred to as "ASSIGNEES," are desirous of acquiring ASSIGNORS' interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same as joint assignees;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignors, Assignors have sold, assigned and transferred, and by these presents do sell, assign and transfer unto the said Assignees, and Assignees' successors and assigns, all their right, title and interest in and to the said invention and application including any corresponding foreign application, and in and to any Letters Patent which may hereafter be granted on the same in the United States and any corresponding foreign application, the said interest to be held and enjoyed by said Assignees as fully and exclusively as it would have been held and enjoyed by said Assignors had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignors further agree that they will, without charge to Assignees, but at Assignees' expense, cooperate with Assignees in the prosecution of said application and/or applications, examine, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignees lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in Assignees, or Assignees' successors and assigns.

Assignors hereby authorize and request AMPACC Law Group, PLLC, 6150 215th Street SW, Suite 300, Mountlake Terrace, WA 98043, to insert herein above the application number and filing date of said application when known.

IN TESTIMONY WHEREOF, Assignors have signed their names on the dates indicated.

January 9, 2013
Date:

January 7, 2013
Date:

January 7, 2013
Date:

January 7, 2013
Date:

January 7, 2013
Date:

DAE SOON LIM
Name: Dae Soon LIM

Dong Hee SHIN
Name: Dong Hee SHIN

Dong Hyeon LEE
Name: Dong Hyeon LEE

IL HO YANG
Name: IL HO YANG

Yang Bok LEE
Name: Yang Bok LEE